

TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TD62783APA**8CH HIGH-VOLTAGE SOURCE DRIVER**

The TD62783APA is comprised of eight source current transistor array.

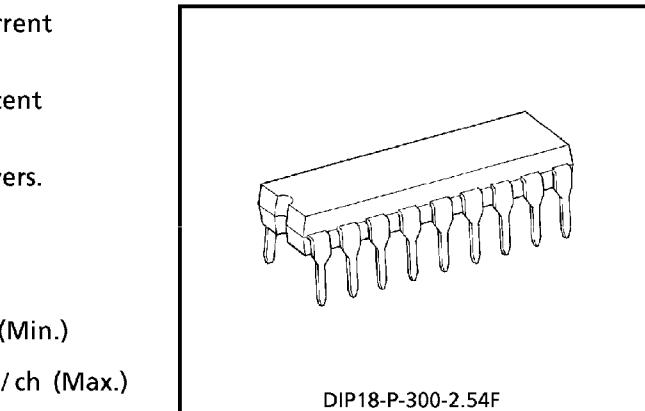
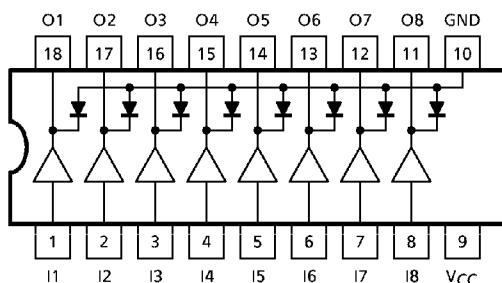
These drivers are specifically designed for fluorescent display applications.

Applications include relay, hammer and lamp drivers.

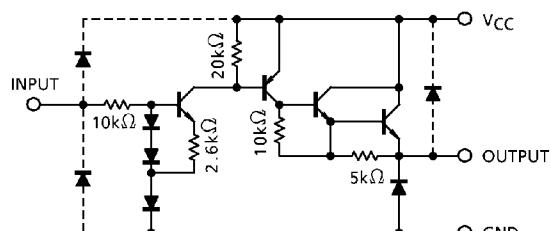
FEATURES

- High output voltage type-APA : $V_{CE(SUS)} = 50V$ (Min.)
- Output current (single output) : $I_{OUT} = -500mA / ch$ (Max.)
- Output clamp diodes
- Single supply voltage
- Input compatible with TTL, 5V CMOS
- Package type-APA : DIP-18 pin

TYPE	DESIGNATION
TD62783APA	TTL, 5V CMOS

PIN CONNECTION (TOP VIEW)

Weight : 1.478g (Typ.)

SCHEMATICS (EACH DRIVER)

(Note) The input and output parasitic diodes cannot be used as clamp diodes.

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MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage	V _{CC}	50	V
Output Current	I _{OUT}	- 500	mA / ch
Input Voltage	V _{IN}	15	V
Clamp Diode Reverse Voltage	V _R	50	V
Clamp Diode Forward Current	I _F	500	mA
Power Dissipation	P _D (Note)	1.47	W
Operating Temperature	T _{opr}	- 40~85	°C
Storage Temperature	T _{stg}	- 55~150	°C

(Note) Delated above 25°C in the proportion of 11.7mW / °C.

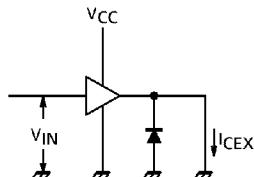
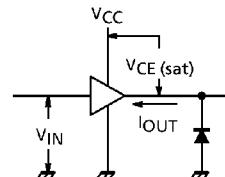
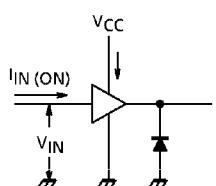
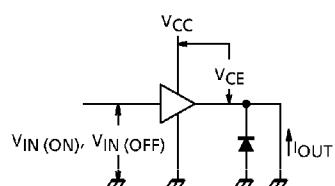
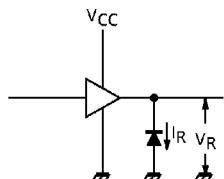
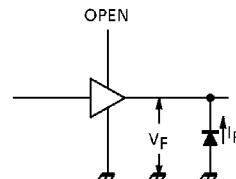
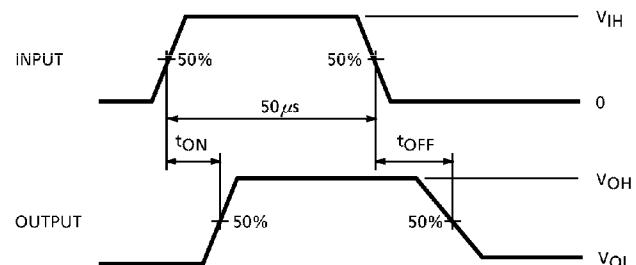
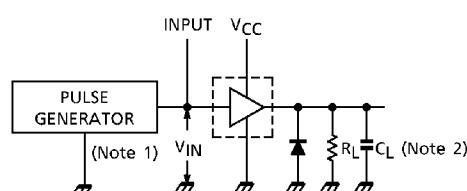
RECOMMENDED OPERATING CONDITIONS (Ta = - 40~85°C)

CHARACTERISTIC	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V _{CC}	—	—	—	50	V
Output Current	I _{OUT}	T _{pw} = 25ms, Duty = 8% 8 Circuits	—	—	- 400	mA / ch
		T _{pw} = 25ms, Duty = 25% 8 Circuits	—	—	- 200	
Input Voltage	V _{IN}	—	—	—	12	V
Input Voltage	Output On	V _{IN} (ON)	—	2.0	5.0	V
	Output Off	V _{IN} (OFF)	—	0	—	0.8 V
Clamp Diode Reverse Voltage	V _R	—	—	—	50	V
Clamp Diode Forward Current	I _F	—	—	—	400	mA
Power Dissipation	P _D	—	—	—	0.52	W

ELECTRICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)

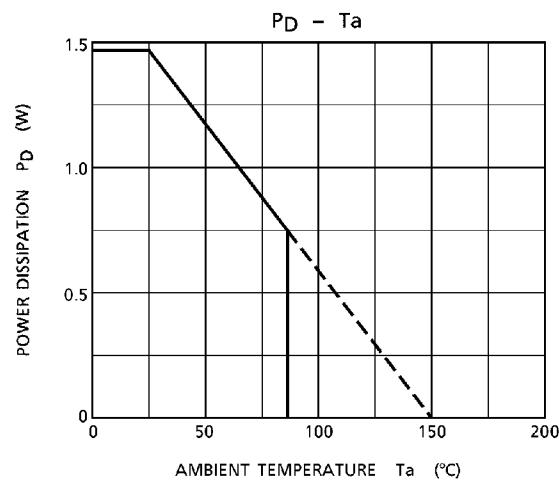
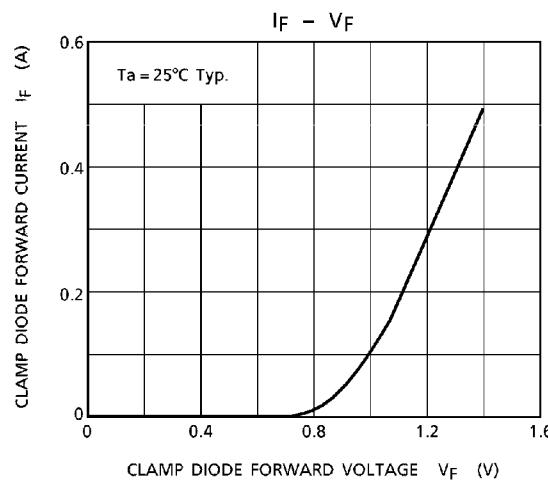
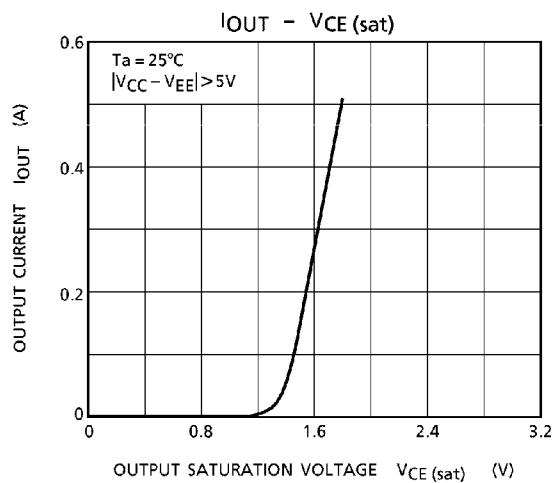
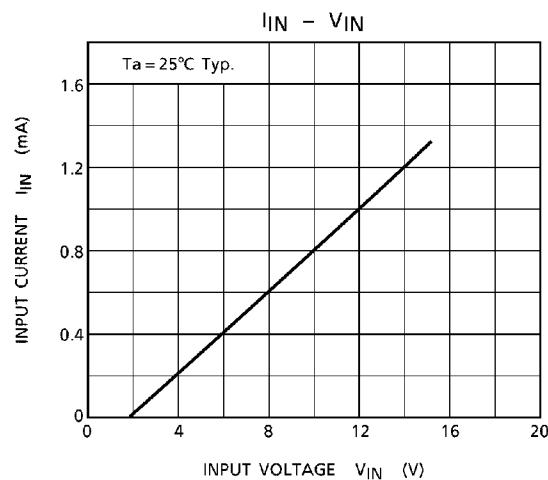
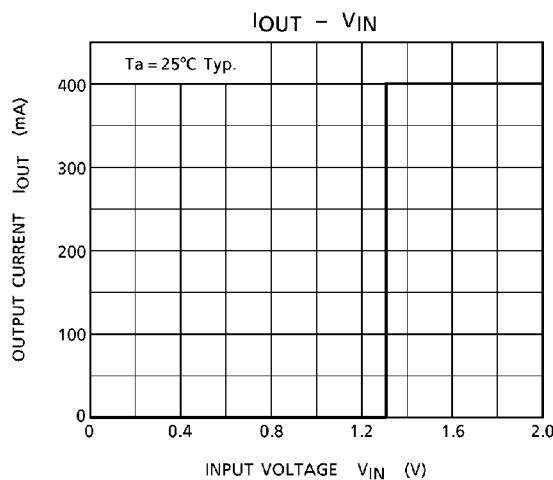
CHARACTERISTIC	SYMBOL	TEST CIR-CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Output Leakage Current	I_{CEX}	1	$V_{CC} = V_{CC \text{ MAX.}}, V_{IN} = 0.4V$ $T_a = 25^\circ\text{C}$	—	—	100	μA
Output Saturation Voltage	$V_{CE \text{ (sat)}}$	2	$V_{IN} = V_{IN \text{ (ON)}}, I_{OUT} = -350\text{mA}$	—	—	2.0	V
			$V_{IN} = V_{IN \text{ (ON)}}, I_{OUT} = -225\text{mA}$	—	—	1.9	
			$V_{IN} = V_{IN \text{ (ON)}}, I_{OUT} = -100\text{mA}$	—	—	1.8	
Input Current	$I_{IN \text{ (ON)}}$	3	$V_{IN} = 2.4\text{V}$	—	36	52	μA
			$V_{IN} = 3.85\text{V}$	—	180	260	
Input Voltage	$V_{IN \text{ (ON)}}$	4	$V_{CE} = 2.0\text{V}, I_{OUT} = -350\text{mA}$	—	—	2.0	V
			$I_{OUT} = -500\mu\text{A}$	0.8	—	—	
Supply Current	$I_{CC \text{ (ON)}}$	3	$V_{IN} = V_{IN \text{ (ON)}}, V_{CC} = 50\text{V}$	—	—	2.5	mA / ch
Clamp Diode Leakage Current	I_R	5	$V_R = 50\text{V}$	—	—	50	μA
Clamp Diode Forward Voltage	V_F	6	$I_F = 350\text{mA}$	—	—	2.0	V
Turn-On Delay	t_{ON}	7	$V_{CC} = V_{CC \text{ MAX.}}, R_L = 125\Omega$ $C_L = 15\text{pF}$	—	0.15	—	μs
Turn-Off Delay	t_{OFF}			—	1.8	—	

TEST CIRCUIT

1. I_{CEX} 2. $V_{CE}(\text{sat})$ 3. $I_{IN}(\text{ON}), I_{CC}$ 4. $V_{IN}(\text{ON}), V_{IN}(\text{OFF})$ 5. I_R 6. V_F 7. t_{ON}, t_{OFF} 

PRECAUTIONS for USING

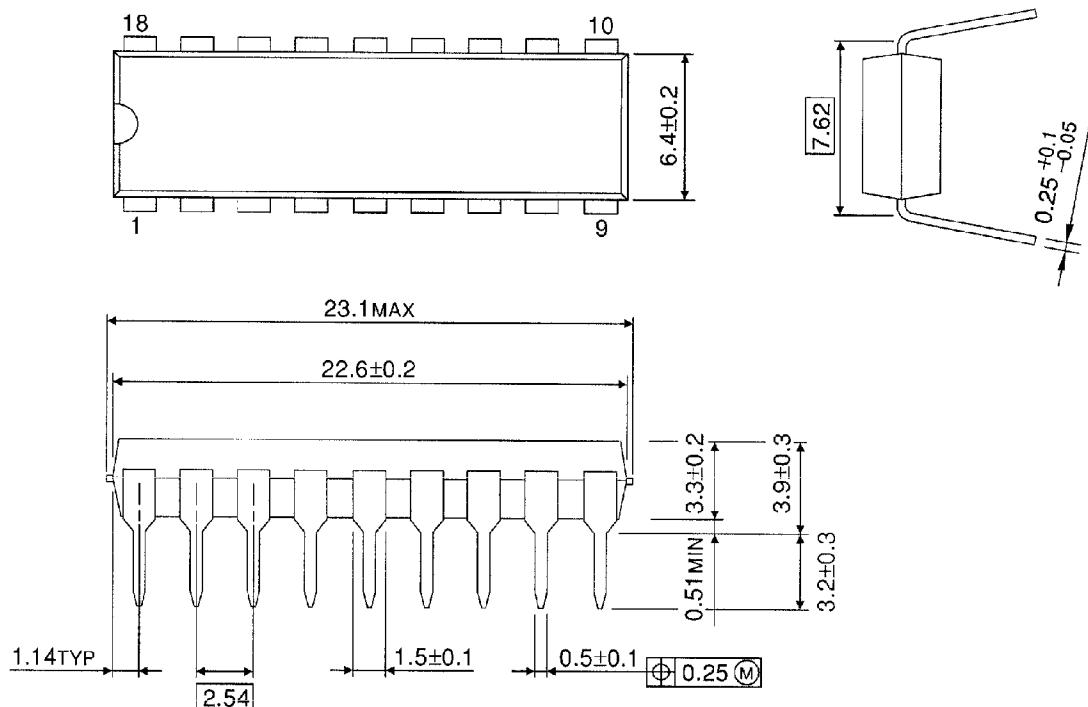
Utmost care is necessary in the design of the output line, V_{CC} and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.



OUTLINE DRAWING

DIP18-P-300-2.54F

Unit : mm



Weight : 1.478g (Typ.)